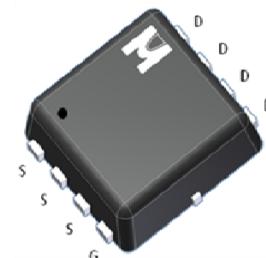
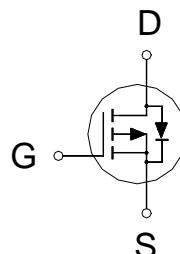


**P-Channel Logic Level Enhancement Mode Field Effect Transistor**

**Product Summary:**

BV <sub>DSS</sub>	-40V
R <sub>DSON</sub> (MAX.)	16mΩ
I <sub>D</sub>	-20A



UIS, R<sub>G</sub> 100% Tested

Pb-Free Lead Plating & Halogen Free



**ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub> = 25 °C Unless Otherwise Noted)**

PARAMETERS/TEST CONDITIONS		SYMBOL	LIMITS	UNIT
Gate-Source Voltage		V <sub>GS</sub>	±20	V
Continuous Drain Current	T <sub>C</sub> = 25 °C	I <sub>D</sub>	-20	A
	T <sub>C</sub> = 100 °C		-13	
Pulsed Drain Current <sup>1</sup>		I <sub>DM</sub>	-80	
Avalanche Current		I <sub>AS</sub>	-15	
Avalanche Energy	L = 0.1mH, I <sub>D</sub> =-15A, R <sub>G</sub> =25 Ω	E <sub>AS</sub>	11.25	mJ
Repetitive Avalanche Energy <sup>2</sup>	L = 0.05mH	E <sub>AR</sub>	5.62	
Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.5	W
	T <sub>A</sub> = 100 °C		1.25	
Operating Junction & Storage Temperature Range		T <sub>j</sub> , T <sub>stg</sub>	-55 to 150	°C

**THERMAL RESISTANCE RATINGS**

THERMAL RESISTANCE	SYMBOL	TYPICAL	MAXIMUM	UNIT
Junction-to-Case	R <sub>θJC</sub>	6	50	°C / W
Junction-to-Ambient <sup>3</sup>	R <sub>θJA</sub>			

<sup>1</sup>Pulse width limited by maximum junction temperature.

<sup>2</sup>Duty cycle ≤ 1%

<sup>3</sup>50°C / W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper.

ELECTRICAL CHARACTERISTICS ( $T_c = 25^\circ\text{C}$ , Unless Otherwise Noted)

PARAMETER	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
STATIC						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{GS} = 0V, I_D = -250\mu\text{A}$	-40			V
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = -250\mu\text{A}$	-1.0	-1.8	-3.2	
Gate-Body Leakage	$I_{GSS}$	$V_{DS} = 0V, V_{GS} = \pm 20V$		$\pm 100$		nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = -32V, V_{GS} = 0V$		-1		$\mu\text{A}$
		$V_{DS} = -30V, V_{GS} = 0V, T_J = 125^\circ\text{C}$			-10	
On-State Drain Current <sup>1</sup>	$I_{D(\text{ON})}$	$V_{DS} = -5V, V_{GS} = -10V$	-20			A
Drain-Source On-State Resistance <sup>1</sup>	$R_{DS(\text{ON})}$	$V_{GS} = -10V, I_D = -10\text{A}$		14	16	$\text{m}\Omega$
		$V_{GS} = -4.5V, I_D = -8\text{A}$		32	40	
Forward Transconductance <sup>1</sup>	$g_{fs}$	$V_{DS} = -5V, I_D = -10\text{A}$		24		S
DYNAMIC						
Input Capacitance	$C_{iss}$	$V_{GS} = 0V, V_{DS} = -20V, f = 1\text{MHz}$		2950		$\text{pF}$
Output Capacitance	$C_{oss}$			287		
Reverse Transfer Capacitance	$C_{rss}$			250		
Gate Resistance	$R_g$	$V_{GS} = 15\text{mV}, V_{DS} = 0V, f = 1\text{MHz}$		4.0		$\Omega$
Total Gate Charge <sup>1,2</sup>	$Q_g$	$V_{DS} = -10V, V_{GS} = -10V, I_D = -10\text{A}$		45.4		$\text{nC}$
Gate-Source Charge <sup>1,2</sup>	$Q_{gs}$			6.2		
Gate-Drain Charge <sup>1,2</sup>	$Q_{gd}$			8.2		
Turn-On Delay Time <sup>1,2</sup>	$t_{d(\text{on})}$	$V_{DS} = -15V, I_D = -1\text{A}, V_{GS} = -10V, R_{GS} = 2.7\Omega$		12		$\text{nS}$
Rise Time <sup>1,2</sup>	$t_r$			25		
Turn-Off Delay Time <sup>1,2</sup>	$t_{d(\text{off})}$			30		
Fall Time <sup>1,2</sup>	$t_f$			24		
SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ( $T_c = 25^\circ\text{C}$ )						
Continuous Current	$I_S$	$I_F = I_S \text{ A}, V_{GS} = 0V$			-4.5	$\text{A}$
Pulsed Current <sup>3</sup>	$I_{SM}$				-18	
Forward Voltage <sup>1</sup>	$V_{SD}$				-1.2	V
Reverse Recovery Time	$t_{rr}$			30		$\text{nS}$
Reverse Recovery Charge	$Q_{rr}$				25	$\text{nC}$

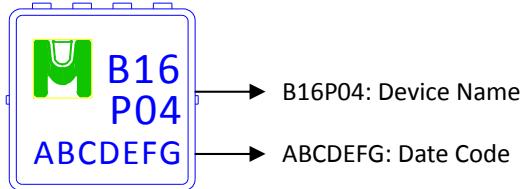
<sup>1</sup>Pulse test : Pulse Width  $\leq 300 \mu\text{sec}$ , Duty Cycle  $\leq 2\%$ .

<sup>2</sup>Independent of operating temperature.

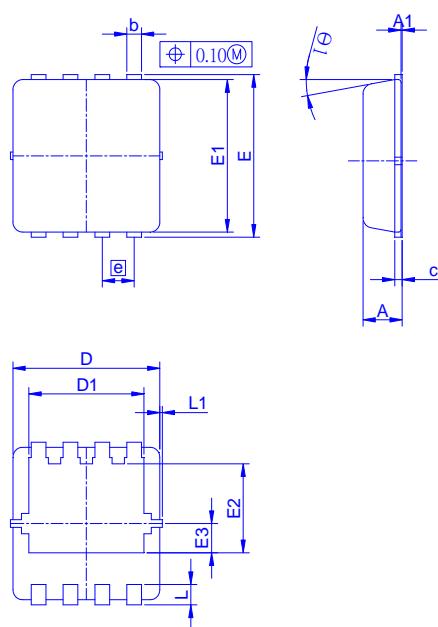
<sup>3</sup>Pulse width limited by maximum junction temperature.

### Ordering & Marking Information:

Device Name: EMB16P04V for EDFN 3 x 3



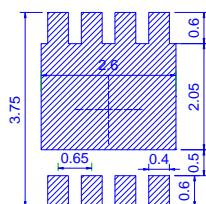
### Outline Drawing



Dimension in mm

Dimension	A	A1	b	c	D	D1	E	E1	E2	E3	e	L	L1	θ1
Min.	0.70	0	0.24	0.10	2.95	2.25	3.15	2.95	1.65			0.30		0°
Typ.	0.80		0.30	0.152	3.00	2.35	3.20	3.00	1.75	0.575	0.65	0.40	0.13	10°
Max.	0.90	0.05	0.37	0.25	3.15	2.45	3.40	3.15	1.96			0.50		12°

### Recommended minimum pads



## TYPICAL CHARACTERISTICS

